



Material Content Data Sheet



Halogen-Free

Sales Product Name	IPD70R600P7S	Issued	26. June 2021
MA#	MA005575413		
Package	PG-TO252-3-344	Weight*	322.19 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.674	0.52	0.52	5195	5195
leadframe	inorganic material	phosphorus	7723-14-0	0.053	0.02		165	
	non noble metal	iron	7439-89-6	0.177	0.06		550	
	non noble metal	copper	7440-50-8	176.899	54.90	54.98	549052	549767
wire	non noble metal	aluminium	7429-90-5	0.559	0.17	0.17	1736	1736
encapsulation	organic material	carbon black	1333-86-4	0.685	0.21		2127	
	plastics	epoxy resin	-	18.502	5.74		57426	
	inorganic material	silicondioxide	60676-86-0	117.864	36.58	42.53	365823	425376
leadfinish	non noble metal	tin	7440-31-5	3.834	1.19	1.19	11898	11898
solder	non noble metal	tin	7440-31-5	0.039	0.01		121	
	noble metal	silver	7440-22-4	0.049	0.02		151	
	non noble metal	lead	7439-92-1	1.854	0.58	0.61	5756	6028
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com